# 74LVT125; 74LVTH125

3.3 V quad buffer; 3-state Rev. 8 — 18 August 2021

**Product data sheet** 

### 1. General description

The 74LVT125; 74LVTH125 is a guad buffer/line driver with 3-state outputs controlled by the output enable inputs (nOE). A HIGH on nOE causes the outputs to assume a high impedance OFF-state. Bus hold data inputs eliminate the need for external pull-up resistors to define unused inputs. This device is fully specified for partial power down applications using  $I_{\text{OFF}}$ . The  $I_{\text{OFF}}$  circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

#### 2. Features and benefits

- Quad bus interface
- 3-state buffers
- Wide supply voltage range from 2.7 to 3.6 V
- BiCMOS high speed and output drive
- Output capability: +64 mA and -32 mA
- Direct interface with TTL levels
- Overvoltage tolerant inputs to 5.5 V
- Bus hold data inputs eliminate need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- No bus current loading when output is tied to 5 V bus
- Power-up 3-state
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Latch-up performance exceeds 500 mA per JESD 78 Class II Level B
- Complies with JEDEC standard JESD8C (2.7 V to 3.6 V)
- ESD protection:
  - HBM EIA/JESD22-A114-A exceeds 2000V
  - MM EIA/JESD22-A115-A exceeds 200V
- Specified from -40 °C to 85 °C

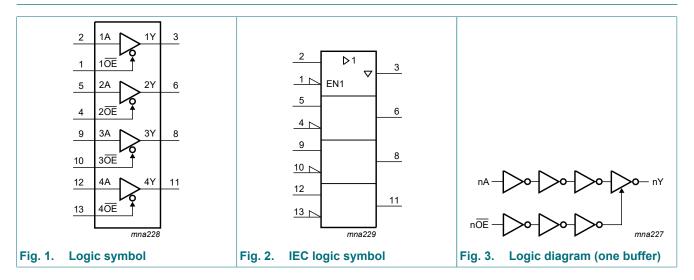
# 3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVT125D	-40 °C to +85 °C	SO14	plastic small outline package; 14 leads;	SOT108-1
74LVTH125D			body width 3.9 mm	
74LVT125PW	-40 °C to +85 °C	TSSOP14	plastic thin shrink small outline package; 14 leads;	SOT402-1
74LVTH125PW			body width 4.4 mm	
74LVT125BQ	-40 °C to +85 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced	SOT762-1
74LVTH125BQ			very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	

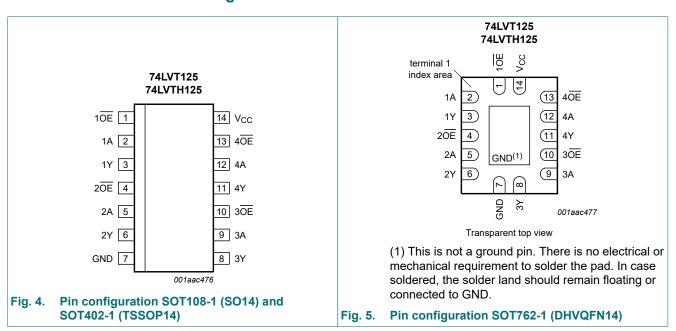


### 4. Functional diagram



# 5. Pinning information

#### 5.1. Pinning



## 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1 <del>OE</del>	1	1 output enable input (active LOW)
1A	2	1 data input
1Y	3	1 data output
2 <del>OE</del>	4	2 output enable input (active LOW)
2A	5	2 data input
2Y	6	2 data output
GND	7	ground (0 V)
3Y	8	3 data output
ЗА	9	3 data input
3 <del>OE</del>	10	3 output enable input (active LOW)
4Y	11	4 data output
4A	12	4 data input
4 <del>OE</del>	13	4 output enable input (active LOW)
V <sub>CC</sub>	14	supply voltage

# 6. Functional description

#### Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care; \ Z = high-impedance \ OFF-state.$ 

	Input	Output
nŌĒ	nA	nY
L	L	L
L	Н	Н
Н	X	Z

## 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
VI	input voltage	[1]	-0.5	+7.0	V
Vo	output voltage	output in OFF-state or HIGH-state [1]	-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-	-50	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-	-50	mA
Io	output current	output in LOW-state	-	128	mA
		output in HIGH-state	-	-64	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature	[2]	-	150	°C

<sup>[1]</sup> The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

## 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		2.7	-	3.6	V
VI	input voltage		0	-	5.5	V
V <sub>IH</sub>	HIGH-level input voltage		2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage		-	-	0.8	V
I <sub>OH</sub>	HIGH-level output current		-	-	-32	mA
I <sub>OL</sub>	LOW-level output current	none	-	-	32	mA
		current duty cycle ≤ 50 %;f ≥ 1 kHz	-	-	64	mA
Δt/ΔV	input transition rise and fall rate		0	-	10	ns/V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+85	°C

### 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
T <sub>amb</sub> = -	40 °C to +85 °C					
$V_{IK}$	input clamping voltage	$I_{IK}$ = -18 mA; $V_{CC}$ = 2.7 V	-	-0.9	-1.2	V
$V_{OH}$	HIGH-level output voltage	$I_{OH}$ = -100 $\mu$ A; $V_{CC}$ = 2.7 V to 3.6 V	V <sub>CC</sub> - 0.2	V <sub>CC</sub> - 0.1	-	V
		$I_{OH}$ = -8 mA; $V_{CC}$ = 2.7 V	2.4	2.5	-	V
		I <sub>OH</sub> = -32 mA; V <sub>CC</sub> = 3.0 V	2.0	2.2	-	V

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<sup>[2]</sup> The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

	Ol Parameter Conditions	Conditions	Min			Max	Unit
V <sub>OL</sub>	LOW-level output voltage	V <sub>CC</sub> = 2.7 V					
		I <sub>OL</sub> = 100 μA		-	0.1	0.2	V
		I <sub>OL</sub> = 24 mA		-	0.3	0.5	V
		V <sub>CC</sub> = 3.0 V					
		I <sub>OL</sub> = 16 mA		-	0.25	0.4	V
		I <sub>OL</sub> = 32 mA		-	0.3	0.5	V
		I <sub>OL</sub> = 64 mA		-	0.4	0.55	V
l <sub>i</sub>	input leakage current	all input pins					
		V <sub>CC</sub> = 0 V or 3.6 V; V <sub>I</sub> = 5.5 V		-	1	10	μA
		control pins					
		V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND		-	±0.1	±1	μA
		data pins	[2]				
		V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub>		-	0.1	1	μA
		V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 0 V		-	-1	-5	μA
I <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 0 \text{ V to } 4.5 \text{ V}$		-	1	±100	μA
I <sub>BHL</sub>	bus hold LOW current	V <sub>CC</sub> = 3 V; V <sub>I</sub> = 0.8 V	[3]	75	150	-	μA
I <sub>BHH</sub>	bus hold HIGH current	V <sub>CC</sub> = 3 V; V <sub>I</sub> = 2.0 V		-	-150	-75	μA
I <sub>BHLO</sub>	bus hold LOW overdrive current	$V_{CC} = 3.6 \text{ V}; V_I = 0 \text{ V to } 3.6 \text{ V}$		500	-	-	μA
I <sub>BHHO</sub>	bus hold HIGH overdrive current	$V_{CC} = 3.6 \text{ V}; V_I = 0 \text{ V to } 3.6 \text{ V}$		-	-	-500	μA
I <sub>LO</sub>	output leakage current	output in HIGH-state when $V_O > V_{CC}$ ; $V_O = 5.5 \text{ V}$ ; $V_{CC} = 3.0 \text{ V}$		-	60	125	μA
I <sub>O(pu/pd)</sub>	power-up/power-down output current	$V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC};$ $V_I = \text{GND or } V_{CC}; \text{ nOE} = \text{don't care}$	[4]	-	±1	±100	μA
l <sub>oz</sub>	OFF-state output current	$V_{CC}$ = 3.6 V; $V_I$ = $V_{IH}$ or $V_{IL}$					
		output HIGH: V <sub>O</sub> = 3.0 V		-	1	5	μA
		output LOW: V <sub>O</sub> = 0.5 V		-	-1	-5	μΑ
I <sub>CC</sub>	supply current	$V_{CC}$ = 3.6 V; $V_I$ = GND or $V_{CC}$ ; $I_O$ = 0 A					
		outputs HIGH		-	0.13	0.19	mA
		outputs LOW		-	2	7	mA
		outputs disabled [5]		-	0.13	0.19	mA
ΔI <sub>CC</sub>	additional supply current	per input pin; V <sub>CC</sub> = 3 V to 3.6 V; one input at V <sub>CC</sub> - 0.6 V and other inputs at V <sub>CC</sub> or GND	[6]	-	0.1	0.2	mA
Cı	input capacitance	V <sub>I</sub> = 0 V or 3.0 V		-	4	-	pF
-1		T. Control of the Con			1		

<sup>[1]</sup> Typical values are measured at  $V_{CC}$  = 3.3 V and  $T_{amb}$  = 25 °C.

<sup>[2]</sup> Unused pins at V<sub>CC</sub> or GND.

This is the bus hold overdrive current required to force the input to the opposite logic state.

<sup>[4]</sup> This parameter is valid for any  $V_{CC}$  between 0 V and 1.2 V with a transition time of up to 10 ms.

From  $V_{CC}$  = 1.2 V to  $V_{CC}$  = 3.0 V to 3.6 V a transition time of 100  $\mu$ s is permitted. This parameter is valid for  $T_{amb}$  = 25 °C only.

<sup>[5]</sup>  $I_{CC}$  is measured with outputs pulled to  $V_{CC}$  or GND.

<sup>[6]</sup> This is the increase in supply current for each input at the specified voltage level other than V<sub>CC</sub> or GND.

# 10. Dynamic characteristics

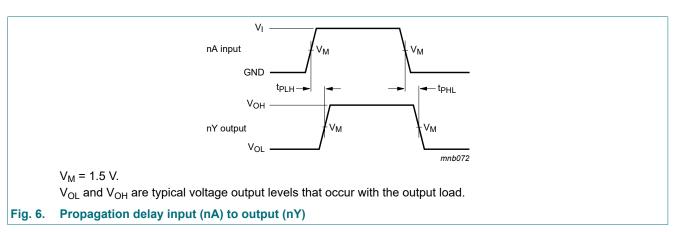
#### **Table 7. Dynamic characteristics**

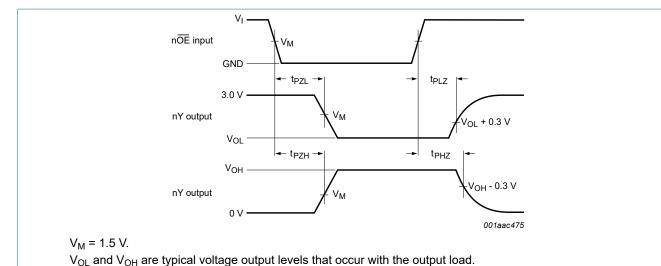
Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 8.

Symbo	Parameter	Conditions	Min	Typ [1]	Max	Unit
T <sub>amb</sub> =	-40 °C to +85 °C					
t <sub>PLH</sub>	LOW to HIGH propagation delay	nAn to nY; see Fig. 6				
		V <sub>CC</sub> = 2.7 V	-	-	4.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.7	4.0	ns
t <sub>PHL</sub>	HIGH to LOW propagation delay	nAn to nY; see Fig. 6				
		V <sub>CC</sub> = 2.7 V	-	-	4.9	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.9	3.9	ns
t <sub>PZH</sub>	OFF-state to HIGH propagation delay	nOE to nY; see Fig. 7				
		V <sub>CC</sub> = 2.7 V	-	-	6.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	3.4	4.7	ns
t <sub>PZL</sub>	OFF-state to LOW propagation delay	nOE to nY; see Fig. 7				
		V <sub>CC</sub> = 2.7 V	-	-	6.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.1	3.4	4.7	ns
t <sub>PHZ</sub>	HIGH to OFF-state propagation delay	nOE to nY; see Fig. 7				
		V <sub>CC</sub> = 2.7 V	-	-	5.7	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.8	3.7	5.1	ns
$t_{PLZ}$	LOW to OFF-state propagation delay	nOE to nY; see Fig. 7				
		V <sub>CC</sub> = 2.7 V	-	-	4.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.3	2.6	4.5	ns

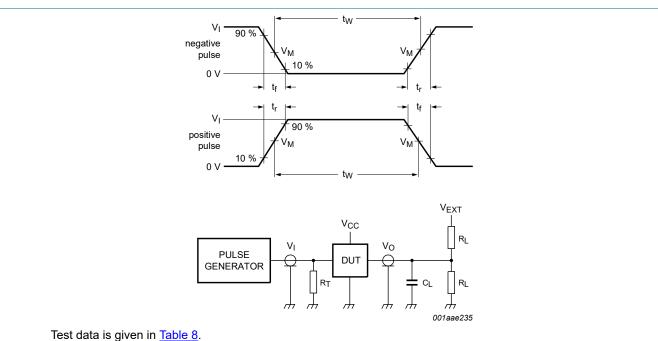
<sup>[1]</sup> Typical values are at  $V_{CC}$  = 3.3 V and  $T_{amb}$  = 25 °C.

#### 10.1. Waveforms and test circuit





Enable and disable times of 3-state outputs Fig. 7.



Definitions test circuit:

R<sub>L</sub> = Load resistance.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

V<sub>EXT</sub> = Test voltage for switching times.

Fig. 8. Test circuit for measuring switching times

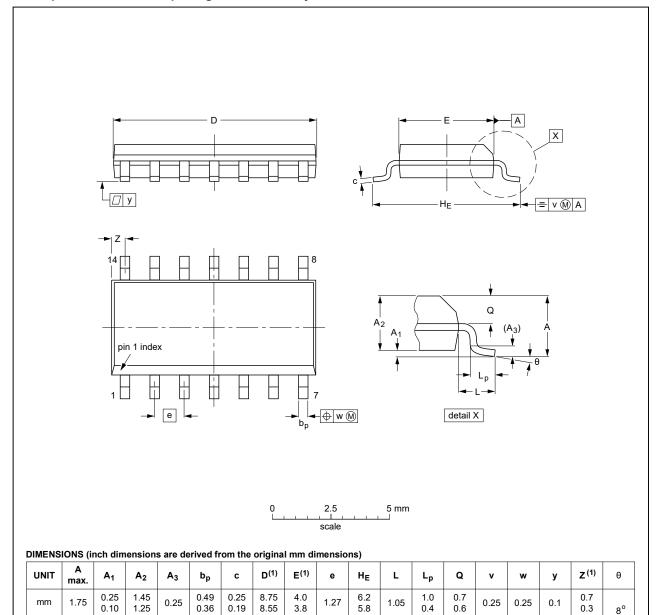
Table 8. Test data

Input				Load		V <sub>EXT</sub>			
$V_{l}$	f <sub>i</sub> t <sub>W</sub>		t <sub>r</sub> , t <sub>f</sub> C <sub>L</sub> R <sub>L</sub>			t <sub>PHZ</sub> , t <sub>PZH</sub>	$t_{PLZ}$ , $t_{PZL}$	t <sub>PLH</sub> , t <sub>PHL</sub>	
2.7	7 V	≤ 10 MHz	500 ns	≤ 2.5 ns	50 pF	500 Ω	GND	6 V	open

# 11. Package outline

#### SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



# inches

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

0.019 0.0100

0.014 | 0.0075

0.35

0.16

0.15

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012				<del>99-12-27</del> 03-02-19

0.05

0.244

0.228

0.041

0.039

0.016

0.028

0.024

0.01

0.01

0.004

Fig. 9. Package outline SOT108-1 (SO14)

0.010

0.004

0.069

0.057

0.049

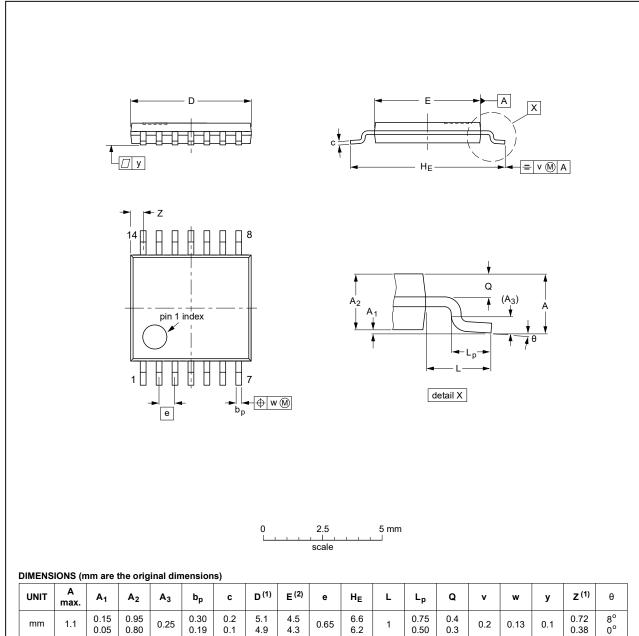
0.01

0.028

0.012

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E (2)	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT402-1		MO-153			<del>99-12-27</del> 03-02-18

Fig. 10. Package outline SOT402-1 (TSSOP14)

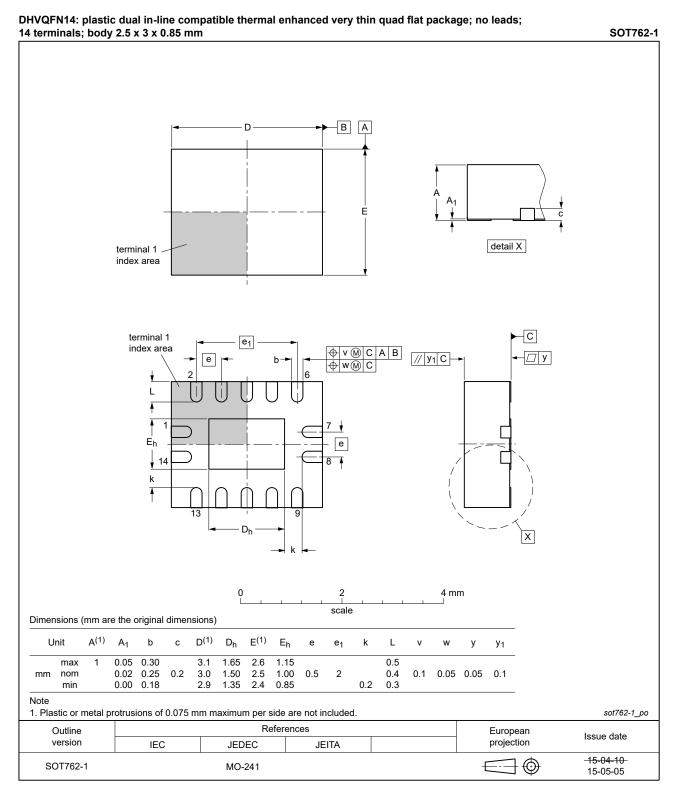


Fig. 11. Package outline SOT762-1 (DHVQFN14)

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### 12. Abbreviations

#### **Table 9. Abbreviations**

Table 417 table 11 ta				
Acronym	Description			
BiCMOS	Bipolar Complementary Metal Oxide Semiconductor			
CMOS	Complementary Metal Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

# 13. Revision history

#### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVT_LVTH125 v.8	20210818	Product data sheet	-	74LVT_LVTH125 v.7
Modifications:	guidelines of Legal texts Type numb Section 1 a	of this data sheet has been of Nexperia. have been adapted to the ers 74LVT125DB and 74L and Section 2 updated. ed with test conditions (eri	new company nar VTH125DB (SOT3	me where appropriate.
74LVT_LVTH125 v.7	20160531	Product data sheet	-	74LVT125 v.6
Modifications:	guidelines o	of this data sheet has been of NXP Semiconductors. have been adapted to the	•	mply with the new identity me where appropriate.
74LVT_LVTH125 v.6	20060306	Product data sheet	-	74LVT125 v.5
Modifications:	• <u>Section 3</u> : A 74LVTH125	•	TH125D, 74LVTH	125DB, 74LVTH125PW and
74LVT125 v.5	20050210	Product data sheet	-	74LVT125 v.4
74LVT125 v.4	20050207	Product data sheet	-	74LVT125 v.3
74LVT125 v.3	20040624	Product data sheet	-	74LVT125 v.2
74LVT125 v.2	19980219	Product specification	-	74LVT125 v.1
74LVT125 v.1		+	1	

### 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
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